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## 1.2A, 30V Step Down DC\_DC converter

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NO.EA-190-100120

### OUTLINE

The R1240x series are CMOS based Step down DC\_DC converter. It has internal Nch high side Tr.( 0.35ΩTyp.) and can provide Maximum 1.2A output current. It consists of an Oscillator, a PWM control circuit, a Reference Voltage unit, an Error amplifier, phase compensation circuits, a slope circuit, a soft-start circuit, protection circuits, internal voltage regulators, a switch for boot strap circuit and so on.

The R1240x series are current mode operating type DC\_DC converter which does not require external current sense resistor, and it works high speed response time, high efficiency and compatible with ceramic capacitors. Operating frequency is internally set at 1.25MHz.

As a protection function it has cycle by cycle peak current limit function, short protection function ( \* ver. A or ver. B), thermal shutdown function and UVLO.

\* Ver. A : Latch type. After detect the over current condition , if output voltage is keep low more than latch timer period the R1240x will be latched to OFF.

\* Ver. B : Fold back protection Type. Keep operating at lower operating frequency in case of short condition and limiting the Lx current.

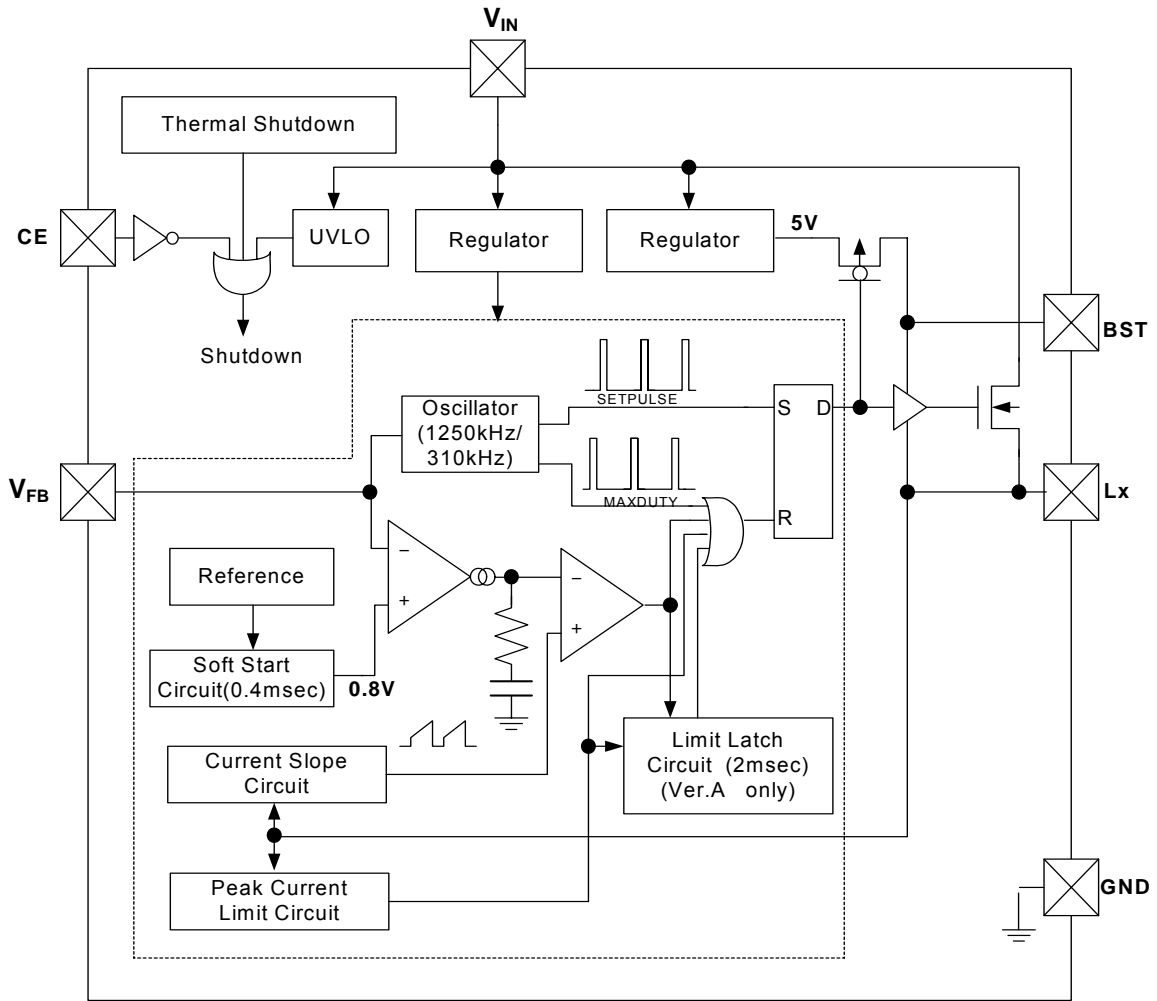
### FEATURES

- Operating Voltage ..... 4.5V~30V
- Internal Nch MOSFET Driver..... Ron=0.35Ω Typ.
- Adjustable output voltage with external resistor ..... 0.8V~15V
- Feed back voltage ..... 0.8V±1.5%
- Peak Current limit function ..... 2.0A Typ.
- UVLO function
- Operating Frequency..... 1.25MHz ( 310kHz : fold condition :Ver. B only)
- Short protection for output ..... Ver. A: Latch with 2ms delay or Ver. B: Fold Back
- Ceramic Capacitor compatible
- Stand-by function ..... 0μA Typ.
- Package ..... SOT-23-6W, DFN(PLP)2527-10

### APPLICATIONS

- Power source for digital home appliance
- Power source for hand-held communication equipment, cameras, video instruments such as VCRs, camcorders.
- Power source for battery-powered equipment.
- Battery Charger

**BLOCK DIAGRAMS**



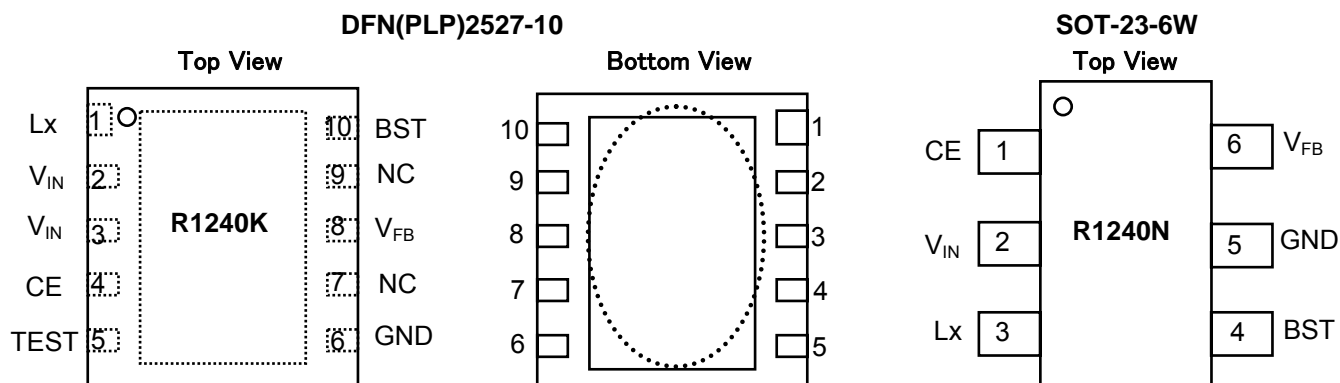
**SELECTION GUIDE**

In the R1240x Series, the Package, type of short protection (Latch or Fold back) can be selected at the user's request.

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R1240K003*-TR	DFN(PLP)2527-10	5,000 pcs	Yes	Yes
R1240N001*-TR-FE	SOT-23-6W	3,000 pcs	Yes	Yes

\* : Designation of Optional Function at off state are options as follows.  
 (A) Latch Type protection  
 (B) Fold back Type protection

## PIN CONFIGURATION



## PIN DESCRIPTION

### ● R1240N001x

Pin No.	Symbol	Description
1	CE	Chip Enable Pin (Active with "H")
2	V <sub>IN</sub>	Power Supply Pin
3	L <sub>x</sub>	Lx Switching Pin
4	BST	Bootstrap Pin
5	GND	Ground Pin
6	V <sub>FB</sub>	Feedback Pin

### ● R1240K003x

Pin No.	Symbol	Description
1	L <sub>x</sub>	Lx Switching Pin
2	V <sub>IN</sub>	Power Supply Pin
3	V <sub>IN</sub>	Power Supply Pin
4	CE	Chip Enable Pin (Active with "H")
5	TEST	Test Pin (Open, do not connect to any line.)
6	GND	Ground Pin
7	NC	No Connection
8	V <sub>FB</sub>	Feedback Pin
9	NC	No Connection
10	BST	Bootstrap Pin

\* Tab is GND level. (They are connected to the reverse side of this IC.)

The tab is better to be connected to the GND, but leaving it open is also acceptable.

## ABSOLUTE MAXIMUM RATINGS

(GND=0V)

Symbol	Item		Rating	Unit	
$V_{IN}$	Input Voltage		-0.3~32	V	
$V_{BST}$	BST Pin Voltage		$V_{LX}-0.3\sim V_{LX}+6$	V	
$V_{LX}$	$L_X$ Pin Voltage		$-0.3\sim V_{IN}+0.3$	V	
$I_{LX}$	$L_X$ Pin Current		2	A	
$V_{CE}$	CE Pin input Voltage		$-0.3\sim V_{IN}+0.3$	V	
$V_{FB}$	$V_{FB}$ Pin Voltage		-0.3~4	V	
$P_D$	Power Dissipation	SOT-23-6W	Standard Land Pattern	430*	mW
		DFN(PLP)2527-10	Standard Land Pattern	910*	
			High Wattage Land Pattern	1400*	
$T_a$	Operating Temperature Range		-40~85	°C	
$T_{stg}$	Storage Temperature Range		-55~125	°C	

\*) For Power Dissipation, please refer to PACKAGE INFORMATION.

## ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field.  
The functional operation at or over these absolute maximum ratings is not assured.

## ELECTRICAL CHARACTERISTICS

Otherwise notified in Conditions,  $V_{IN}=12V$

( $T_a=25^{\circ}C$ )

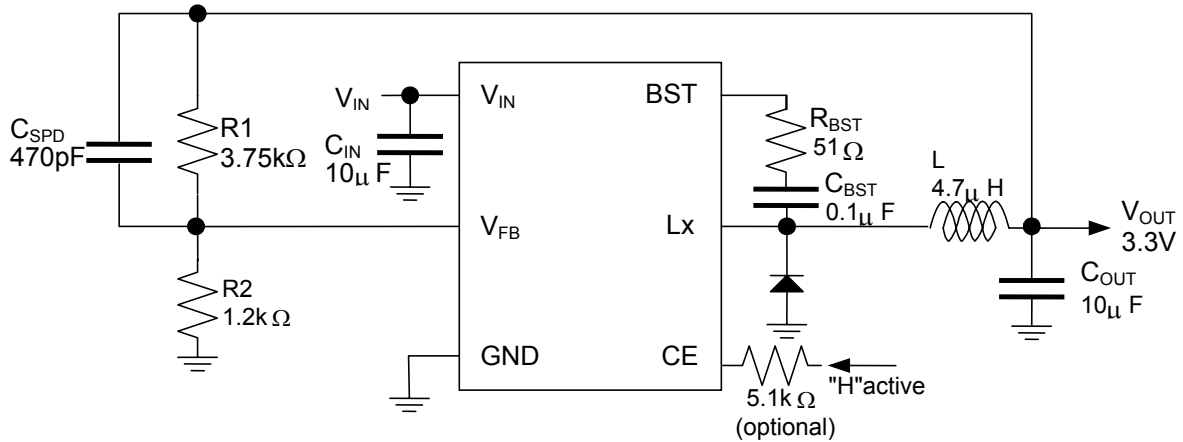
Symbol	Item	Conditions	MIN.	TYP.	MAX.	Unit
$V_{IN}$	Operating Input Voltage		4.5		30	V
$I_{IN}$	$V_{IN}$ consumption current	$V_{IN}=30V, V_{FB}=1.0V$		0.5	1.0	mA
$V_{UVLO1}$	UVLO detect voltage	Falling	3.6	3.8	4.0	V
$V_{UVLO2}$	UVLO released voltage	Rising		$V_{UVLO1}+0.2$	4.2	V
$V_{FB}$	$V_{FB}$ voltage tolerance		0.788	0.800	0.812	V
$\Delta V_{FB}/\Delta T$	$V_{FB}$ voltage temperature coefficient	$-40^{\circ}C \leq T_a \leq 85^{\circ}C$		$\pm 150$		ppm/ $^{\circ}C$
fosc	Oscillator frequency		1000	1250	1500	kHz
$f_{FLB}$	Fold back frequency (Ver.B)	$V_{FB} < 0.56V$		310		kHz
Maxduty	Max. Duty cycle		75	85	90	%
$T_{MIN}$	Minimum on time			100		nsec
$T_{SS}$	Soft Start Time	$V_{FB}=0.72V$	0.2	0.4	0.6	ms
$T_{DLY}$	Delay time for latch protection (Ver.A)		1	2	4	ms
$R_{LXH}$	Lx High side switch ON resistance			0.35		$\Omega$
$I_{LXHOFF}$	Lx High side switch leakage current			0	5	$\mu A$
$I_{LIMLXH}$	Lx High side switch limited current			2.0		A
$V_{CEL}$	CE "L" input voltage				0.3	V
$V_{CEH}$	CE "H" input voltage		1.6			V
$I_{FB}$	$V_{FB}$ Input Current		-1.0		1.0	$\mu A$
$I_{CEL}$	CE "L" input current		-1.0		1.0	$\mu A$
$I_{CEH}$	CE "H" input current		-1.0		1.0	$\mu A$
$T_{TSD}$	Thermal Shutdown Detect Temperature	Hysteresis $30^{\circ}C$		160		$^{\circ}C$
$I_{STB}$	Standby Current	$V_{IN}=30V$		0	5	$\mu A$

### RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge.

And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

TYPICAL APPLICATION



(external parts)

<b>C<sub>IN</sub></b>	10μF KTS500B106M55N0T00 (Nippon Chemi-Con)
<b>C<sub>OUT</sub></b>	10μF GRM31CR71E106K (Murata)
<b>C<sub>BST</sub></b>	0.1μF GRM21BB11H104KA01L (Murata)
<b>L</b>	4.7μH SLF7045T-4R7M2R0-PF (TDK)
<b>D</b>	MA24D60 (Panasonic)

Notes concerning external parts

External components must be connected as close as possible to the ICs and make wiring as short as possible. Especially, the capacitor connected in between V<sub>IN</sub> and GND pin must be wiring the shortest. The operating may be unstable due to the change of the electric potential of internal ICs by the switching current when the impedance of the power supply line and GND line is high. Make the power supply and GND lines sufficient. It is also necessary to give careful consideration to design the wiring of the power supply, GND, L<sub>x</sub>, V<sub>OUT</sub> and the inductor because of the large current by the function of switching is flowing into them. Besides, the wiring between the resistance (R1), which set the output voltage, and the wiring of the inductor must separate from the load wiring.

The ceramic capacitors have low ESR (Equivalent Series Resistance) type are recommended for the ICs. The recommendation of C<sub>IN</sub> capacitor between V<sub>IN</sub> and GND is more than 10μF, and C<sub>OUT</sub> capacitor is more than 10μF in the case V<sub>OUT</sub> ≥ 1.8V or more than 20μF in the case 1.8V > V<sub>OUT</sub>. Please check the bias dependence and the temperature variations of the ceramic capacitors.

Normally, please select the inductor value in the range between 4.7μH and 10μH in the case of V<sub>OUT</sub> ≥ 5V, 4.7μH in the case of 5V > V<sub>OUT</sub> ≥ 1.8V and 2.2μH in the case of 1.8V > V<sub>OUT</sub>. The internal phase compensation of this IC is designed with the above-mentioned inductor value and C<sub>OUT</sub> ceramic capacitor value. When the inductor value is small, there is a possibility to trigger the over-current protection circuit by the peak switching current. As the peak switching current might reach to the limited value when the load current increase a lot.

Please note; the over-current protection circuit is influenced by the temperature shift caused by operation of the IC.

For the diode, please use the Schottky diode, which parasitic capacitance is small as possible, as, there is a possibility that the operating of IC becomes unstable by the large switching current.

Output voltage is set by V<sub>OUT</sub> = V<sub>FB</sub> × (R1 + R2) / R2. If the values of R1 and R2 are large, the impedance of V<sub>FB</sub> pin increases, and pickup the noise may result. The recommendation value range of R2 is approximately between 1.2kΩ to 16kΩ. If the operation may be unstable, reduce the impedance of V<sub>FB</sub> pin.

## Recommended value for each output voltage

V <sub>OUT</sub> (V)	0.8	1	1.2	1.3	1.5	1.8~6	6~15
R1(kΩ)	0	=(V <sub>OUT</sub> / 0.8 - 1) × 1.2					
R2 (kΩ)	open	1.20	1.20	1.20	1.20	1.20	1.20
C <sub>SPD</sub> (pF)	open	3300	2200	1500	470	470	330
C <sub>OUT</sub> (μF)	22 x 2	10 x 2	10 x 2	10 x 2	10 x 2	10	10
L (μH)	2.2	2.2	2.2	2.2	2.2	4.7	10.0(4.7)

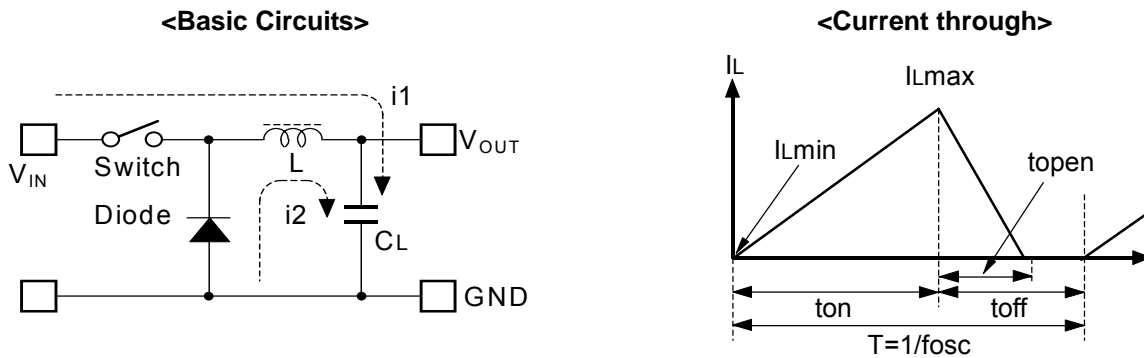
## Recommended external Components

Symbol	Condition	Value	Parts Name	MFR
C <sub>IN</sub>		10 μF/50V	UMK325BJ106MM-T	YUDEN
		10 μF/50V	KTS500B106M55N0T00	Nippon Chemi-Con
C <sub>OUT</sub>	V <sub>OUT</sub> > 10V  10V > V <sub>OUT</sub> > 1.8V V <sub>OUT</sub> < 1.8V	10 μF/50V	UMK325BJ106MM-T	YUDEN
		10 μF/50V	KTS500B106M55N0T00	Nippon Chemi-Con
		10 μF/25V	GRM31CR71E106K	muRata
		22μF/10V	GRM31CR71A226M	muRata
			NOTE: The value of C <sub>OUT</sub> depends upon the setting output voltage.	
C <sub>BST</sub>		0.1 μF/50V	GRM21BB11H104KA01L	muRata
R <sub>BST</sub>		51.0 Ω		
L	40V/2.0A	10 μH	SLF6045T-100M1R6-3PF	TDK
		4.7 μH	SLF7045T-4R7M2R0-PF	TDK
		2.2 μH	VLCF4020T-2R2N1R7	TDK
D	30V/2.0A	0.32V	CMS06	TOSHIBA
	40V/2.0A	0.49V	CMS11	TOSHIBA
	30V/1.5A	0.42V	MA22D28	Panasonic
	40V/2.0A	0.43V	MA24D60	Panasonic
			NOTE: Diode depends upon the input voltage and output Current.	
R <sub>CE</sub>	The UP DIODE is connected between the CE pin and the Vin pin as the ESD protection element. If there is the possibility that the voltage of the CE pin becomes higher than the voltage of the Vin pin, it is recommended to connect the 5.1kohm resistance with the CE pin for preventing a large current flows into the Vin pin from the CE pin.			

\*The performance of power circuit using those ICs extremely depends upon the peripheral circuits. Pay attention in the selection of the peripheral circuits. In particular, design the peripheral circuits in a way that the values such as voltage, current, and power of each component, PCB patterns and the IC do not exceed their respected rated values. (such as the voltage, current , and power)

## Operation of The Buck Converter and The Output Current

The DC/DC converter charges energy in the inductor when switch is ON, and discharges the energy from the inductor when switch is OFF and controls with less energy loss, so that a lower output voltage than the input voltage is obtained. The operation will be explained with reference to the following diagrams:



- Step 1: Switch turns on and current  $I_L (=i_1)$  flows, and energy is charged into  $C_L$ . At this moment,  $I_L$  increases from  $I_{Lmin} (=0)$  to reach  $I_{Lmax}$  in proportion to the on-time period ( $t_{on}$ ) of Switch.
- Step 2: When Switch turns off, Synchronous rectifier Diode turns on in order that  $L$  maintains  $I_L$  at  $I_{Lmax}$ , and current  $I_L (=i_2)$  flows.
- Step 3:  $I_L (=i_2)$  decreases gradually and reaches  $I_L = I_{Lmin} = 0$  after a time period of  $t_{open}$ , and Diode turns off. Provided that in the continuous mode, next cycle starts before  $I_L$  becomes to 0 because  $t_{off}$  time is not enough. In this case,  $I_L$  value increases from this  $I_{Lmin} (>0)$ .

In the case of PWM control system, the output voltage is maintained by controlling the on-time period ( $t_{on}$ ), with the oscillator frequency ( $f_{osc}$ ) being maintained constant.

## Output Current and Selection of External Components

The relation between the output current and external components is as follows:

When Switch of Lx is ON:

(Wherein, Ripple Current P-P value is described as  $I_{RP}$ , ON resistance of Switch and Diode of Lx are respectively described as  $R_{ONH}$  and  $V_f$  and the DC resistor of the inductor is described as  $R_L$ .)

$$V_{IN} = V_{OUT} + (R_{ONH} + R_L) \times I_{OUT} + L \times I_{RP} / t_{on} \dots\dots\dots \text{Equation 1}$$

When Switch is "OFF"(Diode is "ON") as toff:

$$L \times I_{RP} / t_{off} = V_f + V_{OUT} + R_L \times I_{OUT} \dots\dots\dots \text{Equation 2}$$

Put Equation 2 to Equation 1 and solve for ON duty of Switch,  $t_{on} / (t_{off} + t_{on}) = D_{ON}$ ,

$$D_{ON} = (V_{OUT} + V_f + R_L \times I_{OUT}) / (V_{IN} + V_f - R_{ONH} \times I_{OUT}) \dots\dots\dots \text{Equation 3}$$

Ripple Current is as follows:

$$I_{RP} = (V_{IN} - V_{OUT} - R_{ONH} \times I_{OUT} - R_L \times I_{OUT}) \times D_{ON} / f_{osc} / L \dots\dots\dots \text{Equation 4}$$

wherein, peak current that flows through L, and Switch is as follows:

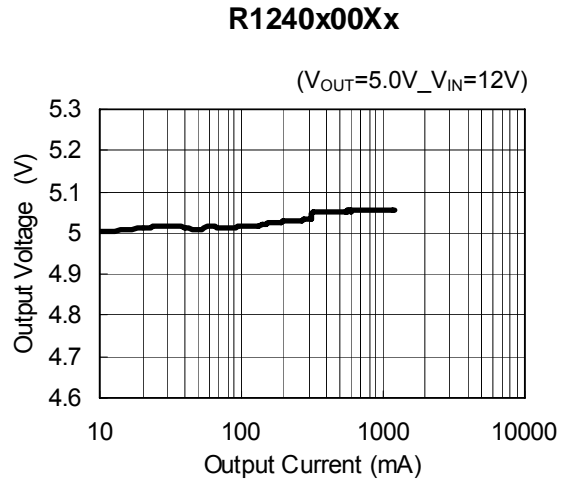
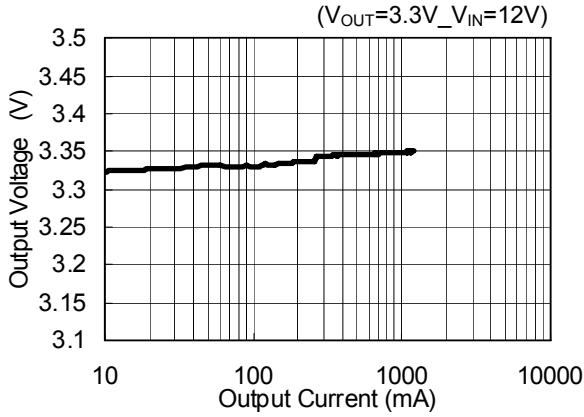
$$I_{Lxmax} = I_{OUT} + I_{RP} / 2 \dots\dots\dots \text{Equation 5}$$

Consider  $I_{Lxmax}$ , condition of input and output and select external components.

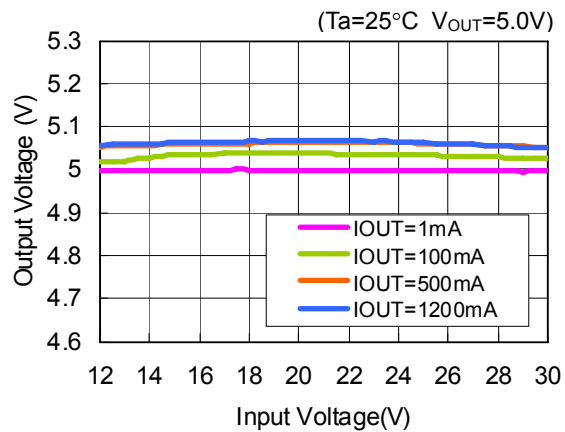
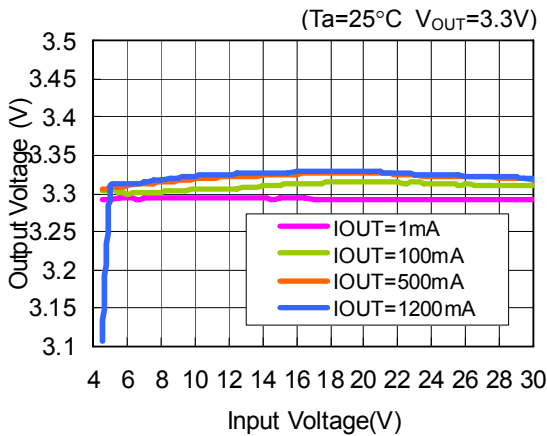
\*The above explanation is directed to the calculation in an ideal case in continuous mode.

## TYPICAL CHARACTERISTICS

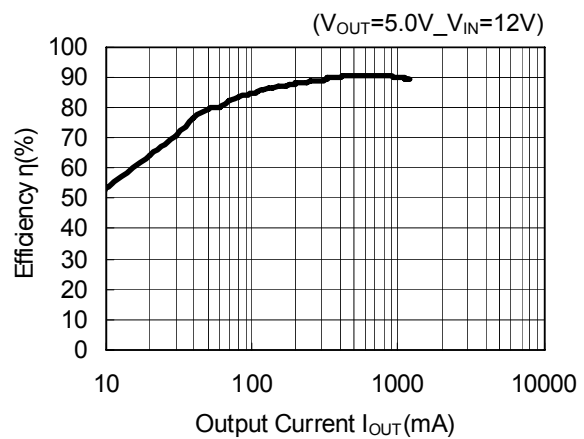
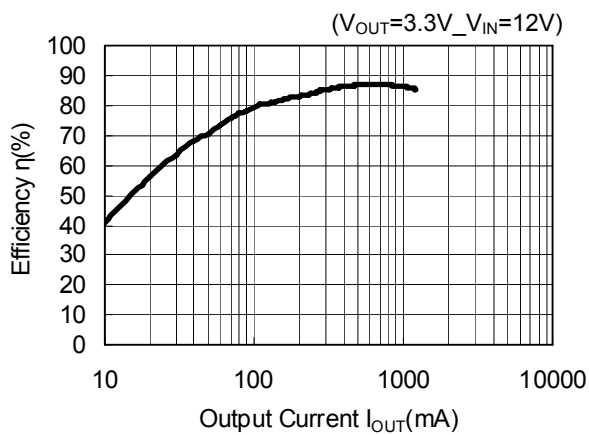
### 1) Output Voltage VS. Output Current R1240x00Xx



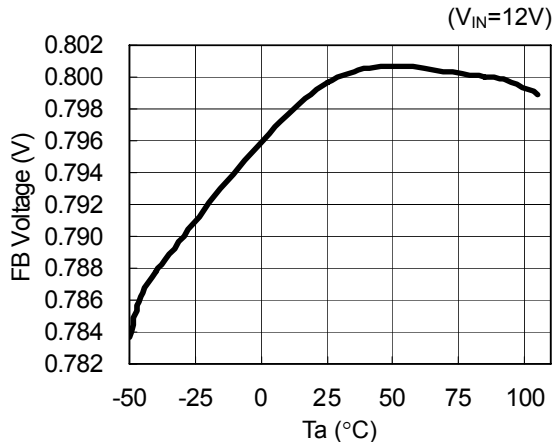
### 2) Output Voltage VS. Input Voltage R1240x00Xx



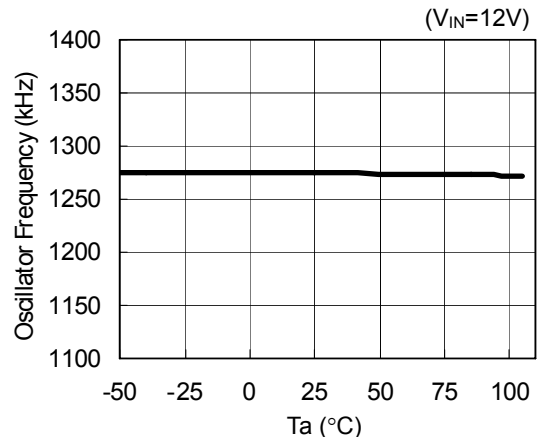
### 3) Efficiency VS. output Current R1240x00Xx



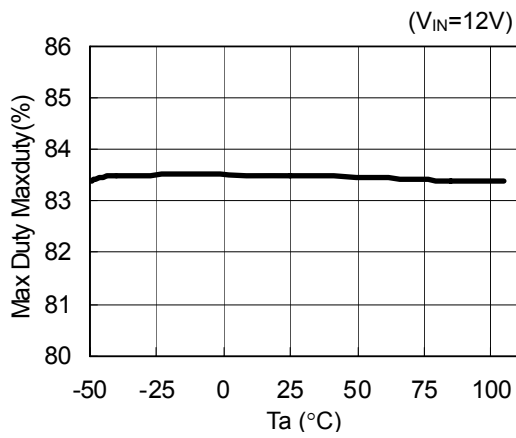
4) FB Voltage VS. Temperature  
R1240x00Xx



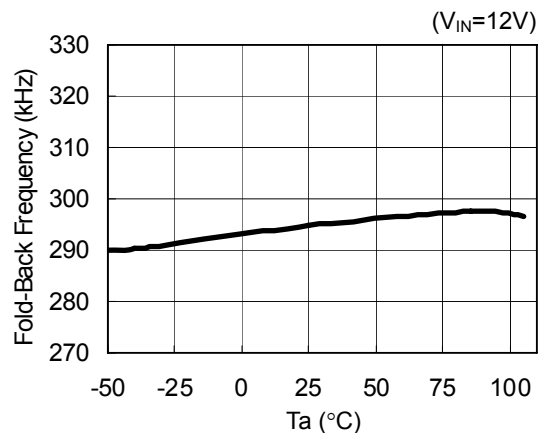
5) Oscillator Frequency VS. Temperature  
R1240x00Xx



6) Maxduty VS. Temperature  
R1240x00Xx



7) Fold-Back Frequency VS. Temperature  
R1240x00XB





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